

## Econo IPM series

## 1200V / 25A 7 in one-package

### Features

- Temperature protection provided by directly detecting the junction temperature of the IGBTs
- Low power loss and soft switching
- High performance and high reliability IGBT with overheating protection
- Higher reliability because of a big decrease in number of parts in built-in control circuit



### Maximum ratings and characteristics

- Absolute maximum ratings(at Tc=25°C unless otherwise specified)

Item		Symbol	Rating		Unit	
			Min.	Max.		
Bus voltage	DC	V <sub>DC</sub>	0	900	V	
	Surge	V <sub>DC(surge)</sub>	0	1000	V	
	Short operating	V <sub>sc</sub>	400	800	V	
Collector-Emitter voltage *1		V <sub>CES</sub>	0	1200	V	
Inverter	Collector current	DC	I <sub>C</sub>	-	25	A
		1ms	I <sub>CP</sub>	-	50	A
	DC	-I <sub>C</sub>	-	25	A	
	Collector power dissipation	One transistor *3	P <sub>C</sub>	-	139	W
Brake	Collector current	DC	I <sub>C</sub>	-	15	A
		1ms	I <sub>CP</sub>	-	30	A
	Forward current diode		I <sub>F</sub>	-	15	A
	Collector power dissipation	One transistor *3	P <sub>C</sub>	-	139	W
Supply voltage of Pre-Driver *4		V <sub>CC</sub>	-0.5	20	V	
Input signal voltage *5		V <sub>in</sub>	-0.5	V <sub>CC</sub> +0.5	V	
Input signal current		I <sub>in</sub>	-	3	mA	
Alarm signal voltage *6		V <sub>ALM</sub>	-0.5	V <sub>CC</sub>	V	
Alarm signal current *7		I <sub>ALM</sub>	-	20	mA	
Junction temperature		T <sub>j</sub>	-	150	°C	
Operating case temperature		T <sub>opr</sub>	-20	100	°C	
Storage temperature		T <sub>stg</sub>	-40	125	°C	
Solder temperature *8		T <sub>sol</sub>	-	260	°C	
Isolating voltage (Terminal to base, 50/60Hz sine wave 1min.)		V <sub>iso</sub>	-	AC2500	V	
Screw torque	Mounting (M5)		-	3.5	N·m	

#### Note

\*1 : V<sub>CES</sub> shall be applied to the input voltage between terminal P and U or ,V or W or DB, N and U or V or W or DB

\*2 :  $125^{\circ}\text{C}/\text{FWD } R_{th(j-c)} / (I_c \times V_F \text{ MAX}) = 125 / 2.05 / (25 \times 2.0) \times 100 > 100\%$

\*3 : P<sub>C</sub>=125°C/IGBT R<sub>th(j-c)</sub>=125/0.90=139W [Inverter]

P<sub>C</sub>=125°C/IGBT R<sub>th(j-c)</sub>=125/0.90=139W [Brake]

\*4 : V<sub>CC</sub> shall be applied to the input voltage between terminal No.4 and 1, 8 and 5, 12 and 9, 14 and 13

\*5 : V<sub>in</sub> shall be applied to the input voltage between terminal No.3 and 1, 7 and 5, 11 and 9, 16,17,18 and 13.

\*6 : V<sub>ALM</sub> shall be applied to the voltage between terminal No.2 and 1, No6 and 5, No10 and 9, No.19 and 13.

\*7 : I<sub>ALM</sub> shall be applied to the input current to terminal No.2,6,10 and 19.

\*8 : Immersion time 10±1sec.

Electrical characteristics (at Tc=Tj=25°C, Vcc=15V unless otherwise specified.)

## ● Main circuit

Item		Symbol	Condition	Min.	Typ.	Max.	Unit	
Inverter	Collector current at off signal input	ICES	VCE=1200V Vin terminal open.	-	-	1.0	mA	
	Collector-Emitter saturation voltage	VCE(sat)	Ic=25A	Terminal	-	-	3.1	V
				Chip	-	2.4	-	
	Forward voltage of FWD	VF	-Ic=25A	Terminal	-	-	2.0	V
Chip				-	1.6	-		
Brake	Collector current at off signal input	ICES	VCE=1200V Vin terminal open.	-	-	1.0	mA	
	Collector-Emitter saturation voltage	VCE(sat)	Ic=15A	Terminal	-	-	2.6	V
				Chip	-	1.9	-	
	Forward voltage of Diode	VF	-Ic=15A	Terminal	-	-	3.3	V
Chip				-	1.9	-		
Turn-on time	ton	VDC=600V, Tj=125°C		1.2	-	-	μs	
Turn-off time	toff	Ic=25A Fig.1, Fig.6		-	-	3.6		
Reverse recovery time	trr	VDC=600V, If=25A Fig.1, Fig.6		-	-	0.3		

## ● Control circuit

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Supply current of P-line side pre-driver(one unit)	Iccp	Switching Frequency : 0 to 15kHz Tc=-20 to 100°C Fig.7	-	-	15	mA
Supply current of N-line side pre-driver	Iccn		-	-	45	mA
Input signal threshold voltage (on/off)	Vin(th)	ON	1.00	1.35	1.70	V
		OFF	1.25	1.60	1.95	V
Input zener voltage	Vz	Rin=20k ohm	-	8.0	-	V
Alarm signal hold time	tALM	Tc=-20°C Fig.2	1.1	-	-	ms
		Tc=25°C Fig.2	-	2.0	-	ms
		Tc=125°C Fig.2	-	-	4.0	ms
Current limit resistor	RALM	Alarm terminal	1425	1500	1575	ohm

## ● Protection Section ( Vcc=15V)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Over Current Protection Level of Inverter circuit	Ioc	Tj=125°C	38	-	-	A
Over Current Protection Level of Brake circuit	Ioc	Tj=125°C	23	-	-	A
Over Current Protection Delay time	tDOC	Tj=125°C	-	5	-	μs
SC Protection Delay time	tSC	Tj=125°C Fig.4	-	-	8	μs
IGBT Chip Over Heating	TjOH	Surface of IGBT chips	150	-	-	°C
Protection Temperature Level						°C
Over Heating Protection Hysteresis	TjH		-	20	-	V
Under Voltage Protection Level	Vuv		11.0	-	12.5	V
Under Voltage Protection Hysteresis	VH		0.2	0.5	-	

## ● Thermal characteristics( Tc=25°C)

Item			Symbol	Min.	Typ.	Max.	Unit
Junction to Case thermal resistance *9	Inverter	IGBT	Rth(j-c)	-	-	0.90	°C/W
		FWD	Rth(j-c)	-	-	2.05	°C/W
	Brake	IGBT	Rth(j-c)	-	-	0.90	°C/W
Case to fin thermal resistance with compound			Rth(c-f)	-	0.05	-	°C/W

\*9 For 1 device, Case is under the device

## ● Noise Immunity ( VDC=300V, Vcc=15V, Test Circuit Fig.5)

Item	Condition	Min.	Typ.	Max.	Unit
Common mode rectangular noise	Pulse width 1μs, polarity ±, 10minuets Judge : no over-current, no miss operating	±2.0	-	-	kV
Common mode lightning surge	Rise time 1.2μs, Fall time 50μs Interval 20s, 10 times Judge : no over-current, no miss operating	±5.0	-	-	kV

## ● Recommendable value

Item	Symbol	Min.	Typ.	Max.	Unit
DC Bus Voltage	VDC	-	-	800	V
Operating Supply Voltage of Pre-Driver	Vcc	13.5	15.0	16.5	V
Screw torque (M5)	-	2.5	-	3.0	Nm

## ● Weight

Item	Symbol	Min.	Typ.	Max.	Unit
Weight	Wt	-	270	-	g

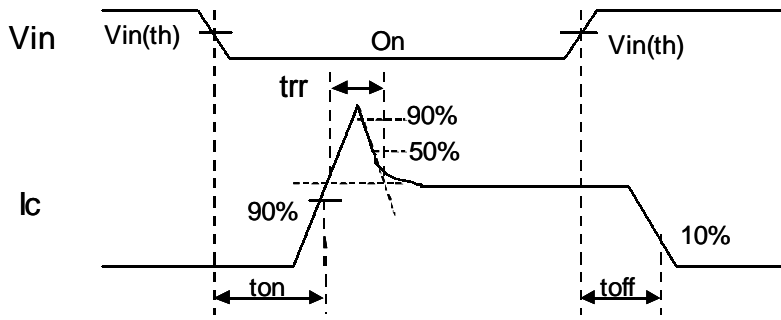


Figure 1. Switching Time Waveform Definitions



Fault : Over-current, Over-heat or Under-voltage

Figure 2. Input/Output Timing Diagram

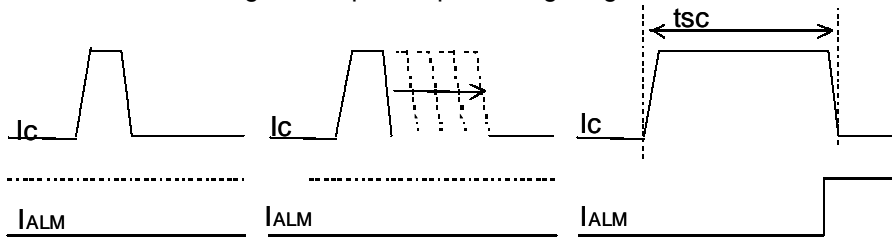


Figure.4 Definition of tsc

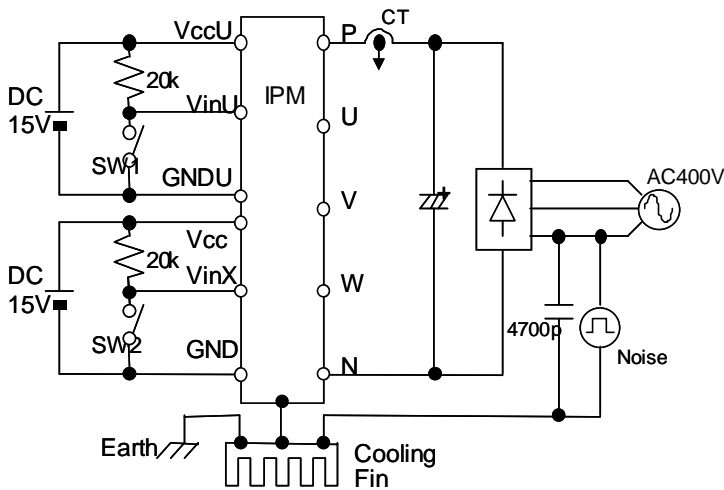


Figure 5. Noise Test Circuit

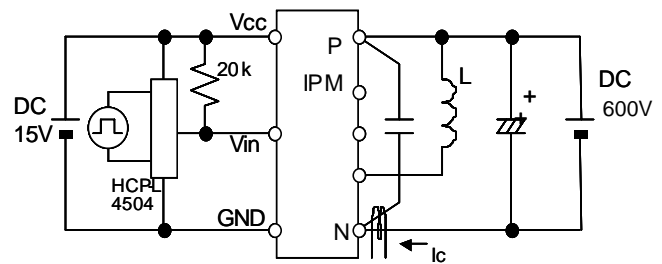


Figure 6. Switching Characteristics Test Circuit

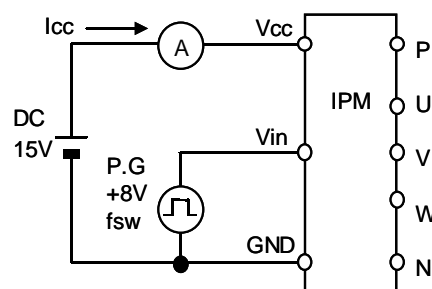
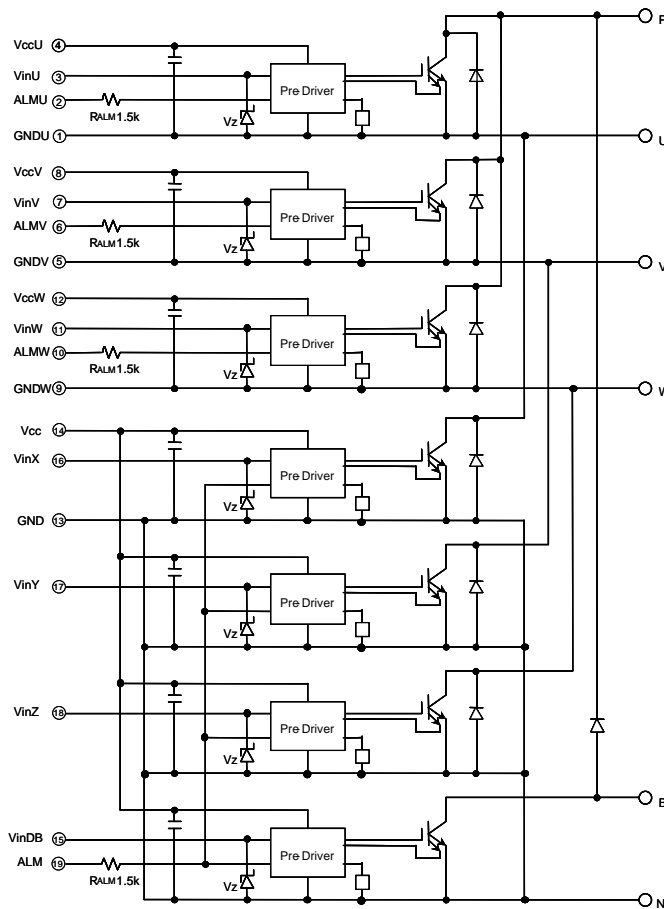


Figure 7. Icc Test Circuit

Block diagram

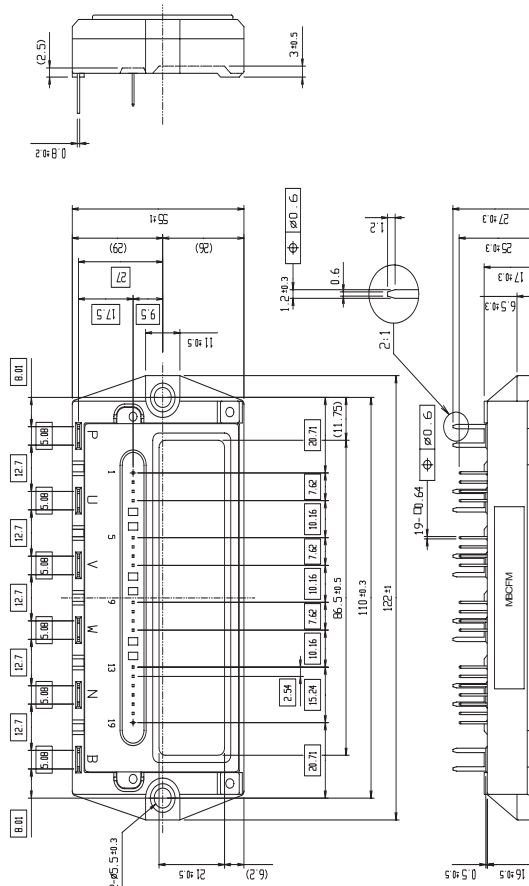


Pre-drivers include following functions

1. Amplifier for driver
2. Short circuit protection
3. Under voltage lockout circuit
4. Over current protection
5. IGBT chip over heating protection

Outline drawings, mm

Package:P622

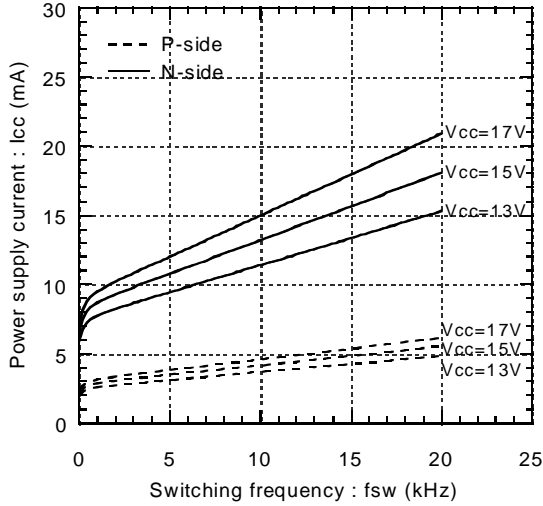


Mass : 270g

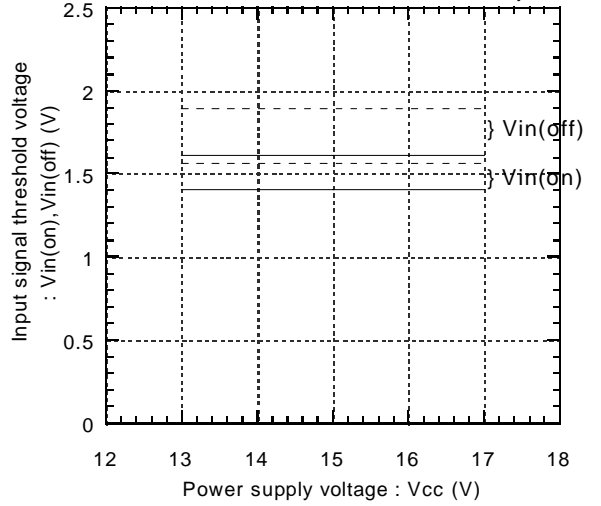
Characteristics

Control circuit characteristics (Representative)

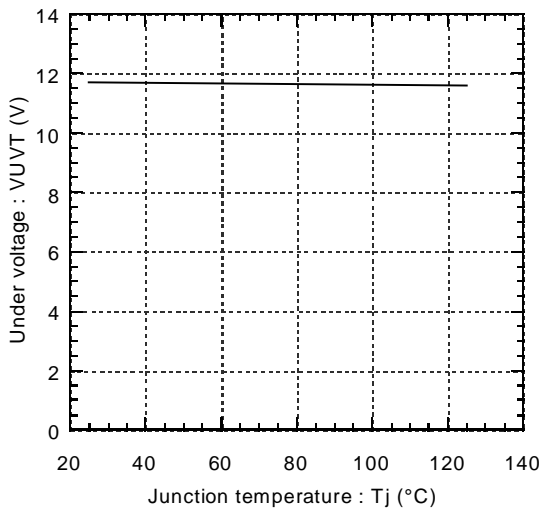
Power supply current vs. Switching frequency  
Tj=125°C (typ.)



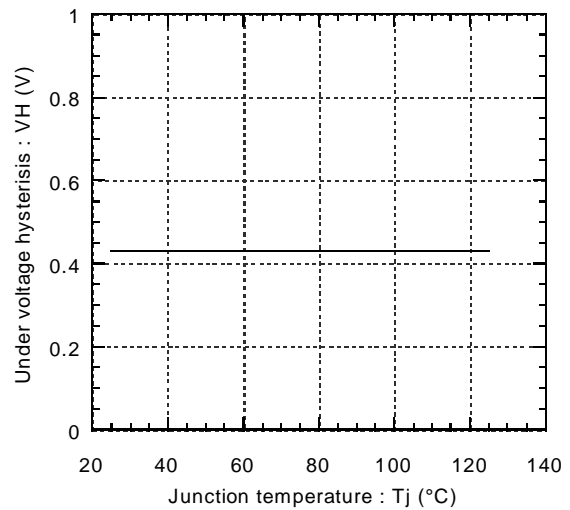
Input signal threshold voltage vs. Power supply voltage (typ.)



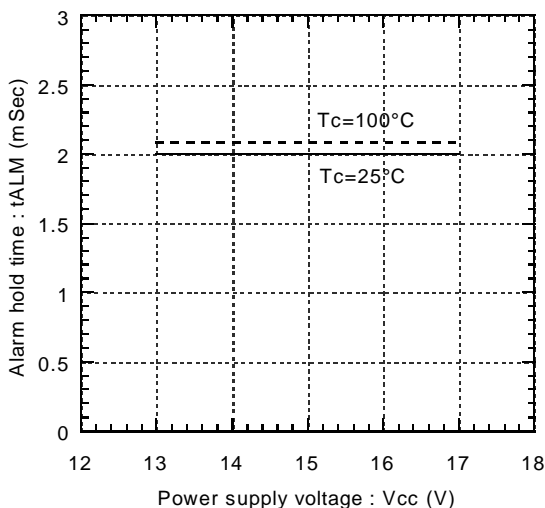
Under voltage vs. Junction temperature (typ.)



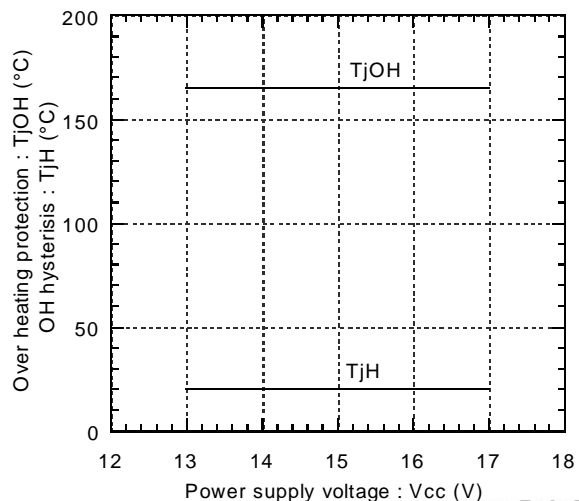
Under voltage hysteresis vs. Junction temperature (typ.)



Alarm hold time vs. Power supply voltage (typ.)

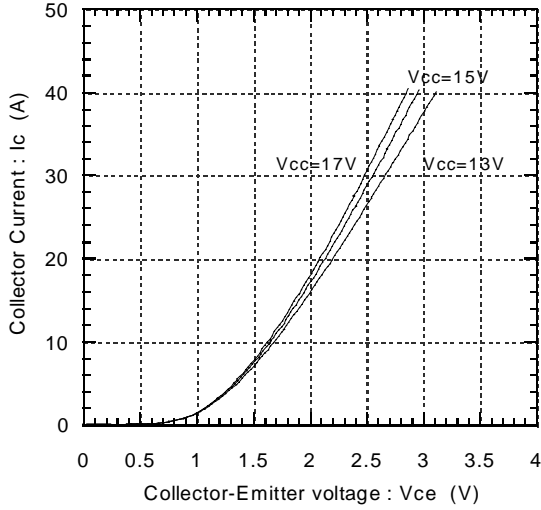


Over heating characteristics  
TjOH, TjH vs. Vcc (typ.)

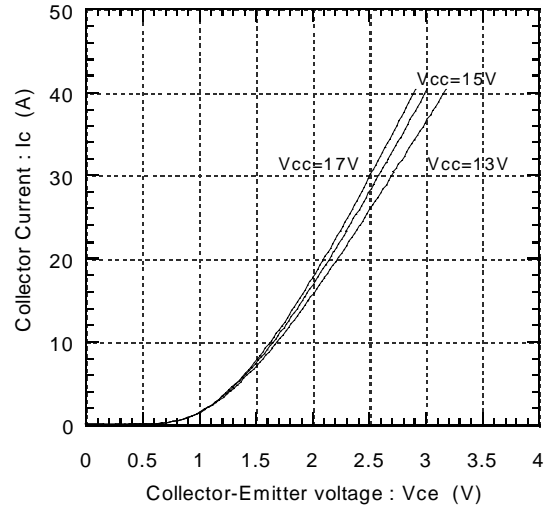


● Main circuit characteristics (Representative)

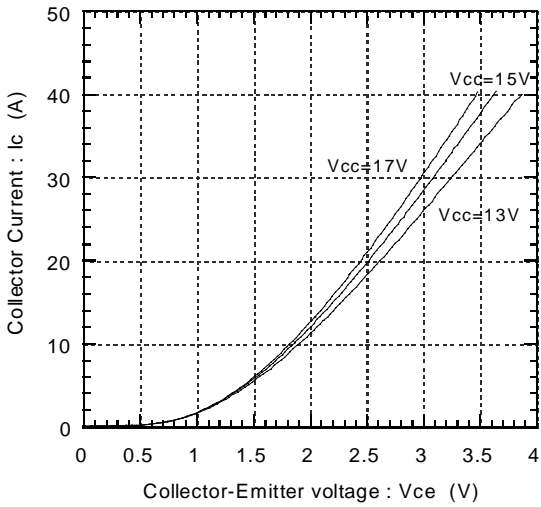
Collector current vs. Collector-Emittor voltage (typ.)  
Tj=25°C / Chip



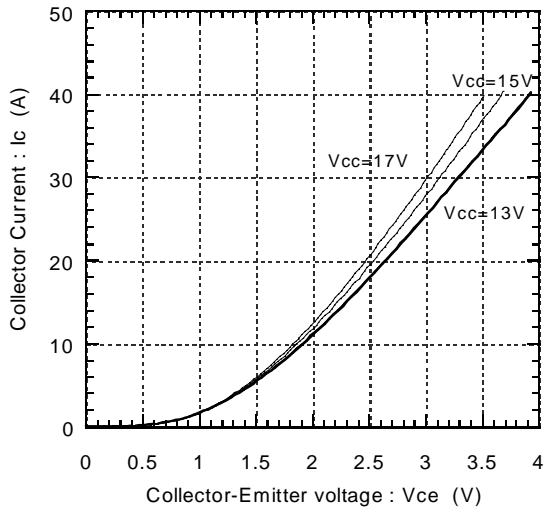
Collector current vs. Collector-Emittor voltage (typ.)  
Tj=25°C / Terminal



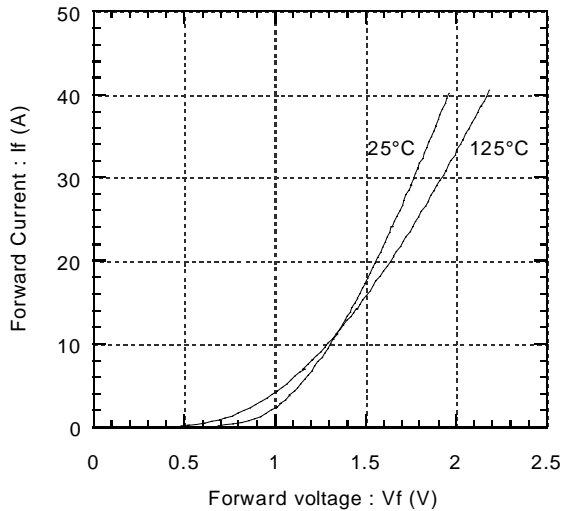
Collector current vs. Collector-Emittor voltage (typ.)  
Tj=125°C / Chip



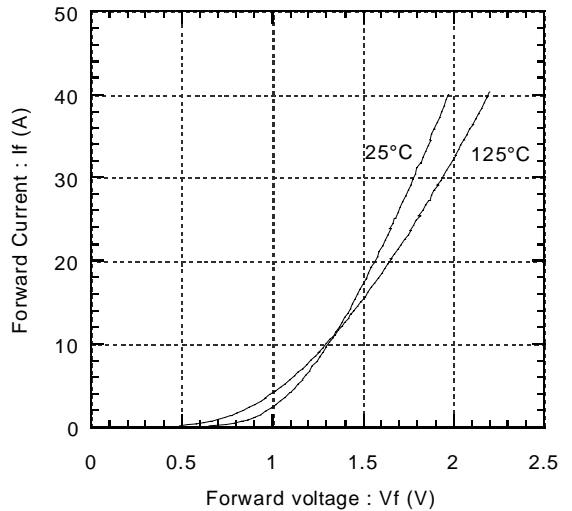
Collector current vs. Collector-Emittor voltage (typ.)  
Tj=125°C / Terminal



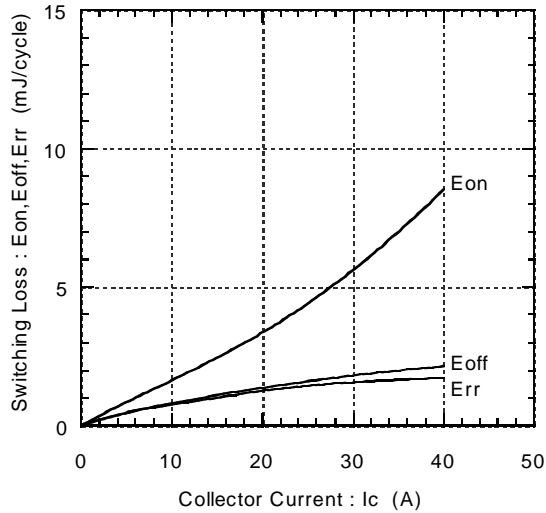
Forward current vs. Forward voltage (typ.)  
Chip



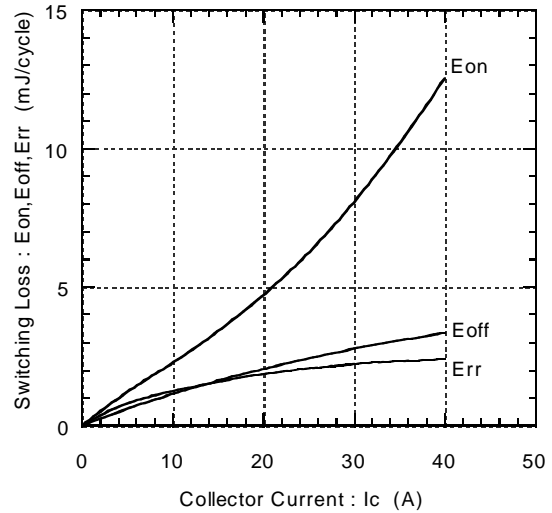
Forward current vs. Forward voltage (typ.)  
Terminal



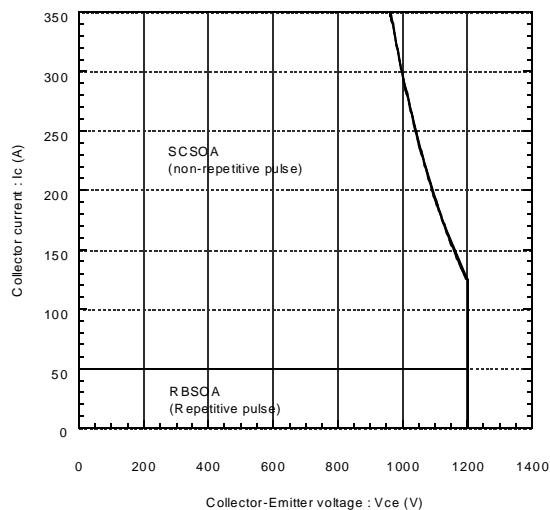
Switching Loss vs. Collector Current (typ.)  
 $E_{dc}=600V, V_{cc}=15V, T_j=25^\circ C$



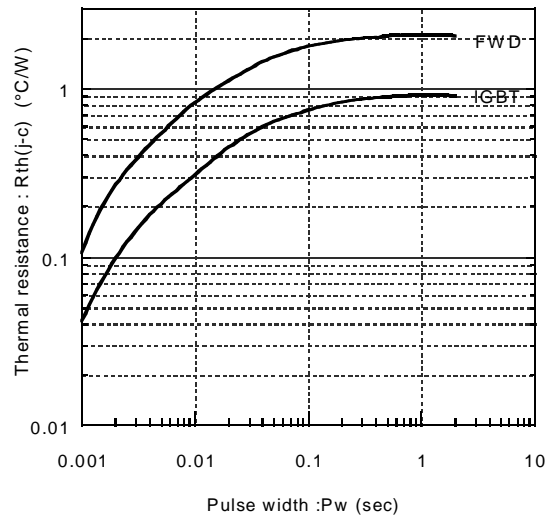
Switching Loss vs. Collector Current (typ.)  
 $E_{dc}=600V, V_{cc}=15V, T_j=125^\circ C$



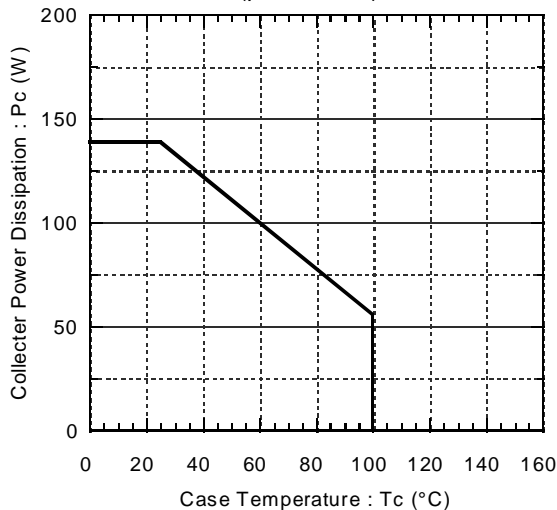
Reversed biased safe operating area  
 $V_{cc}=15V, T_j=25^\circ C$  (min.)



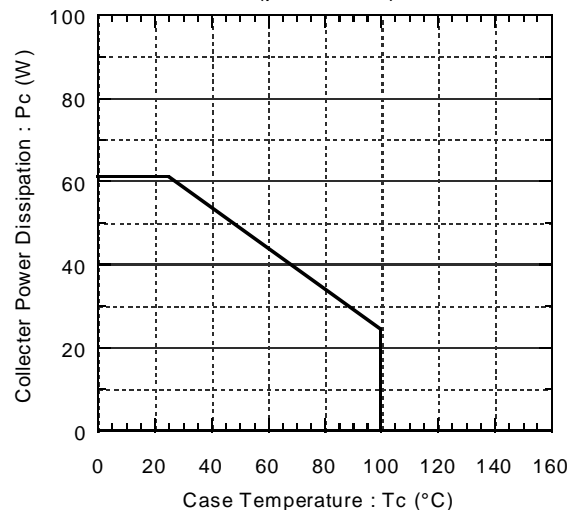
Transient thermal resistance (max.)



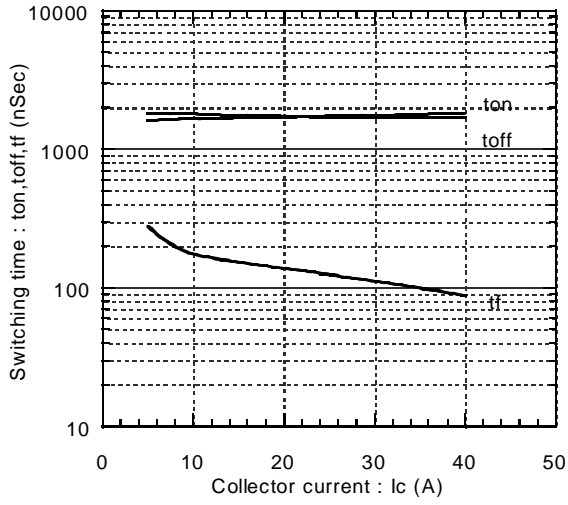
Power derating for IGBT (max.)  
 (per device)



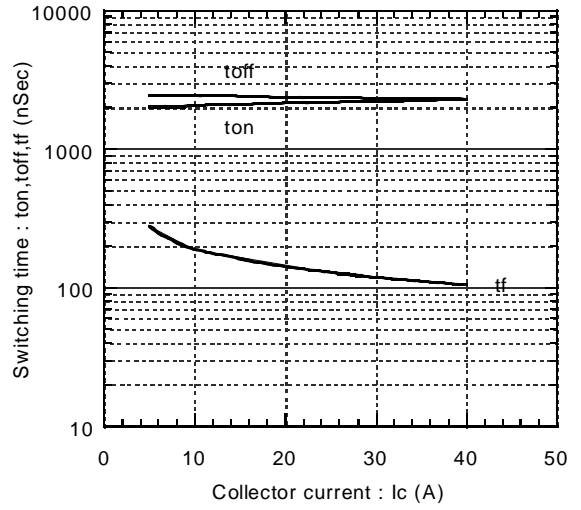
Power derating for FWD (max.)  
 (per device)



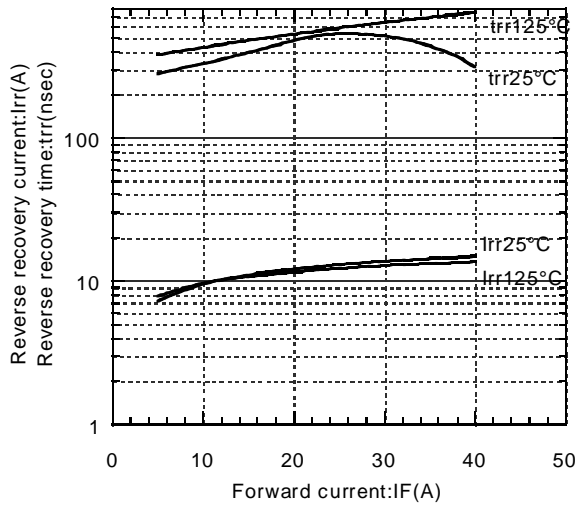
Switching time vs. Collector current (typ.)  
 $E_{dc}=600V, V_{cc}=15V, T_j=25^\circ C$



Switching time vs. Collector current (typ.)  
 $E_{dc}=600V, V_{cc}=15V, T_j=125^\circ C$



Reverse recovery characteristics  
 $t_{rr}, I_{rr}$  vs.  $I_F$  (typ.)

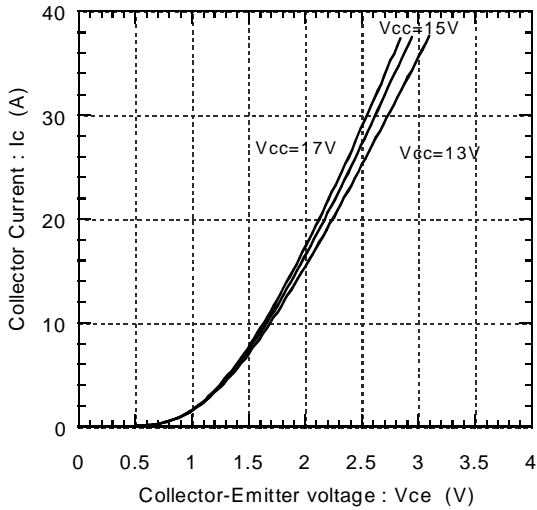




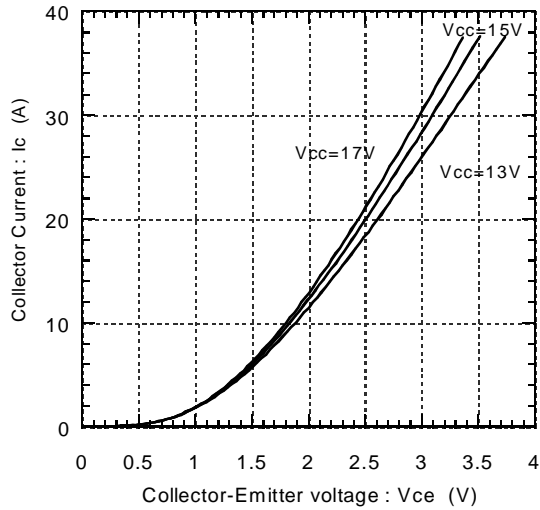
**Characteristics**

● **Dynamic Brake Characteristics (Representative)**

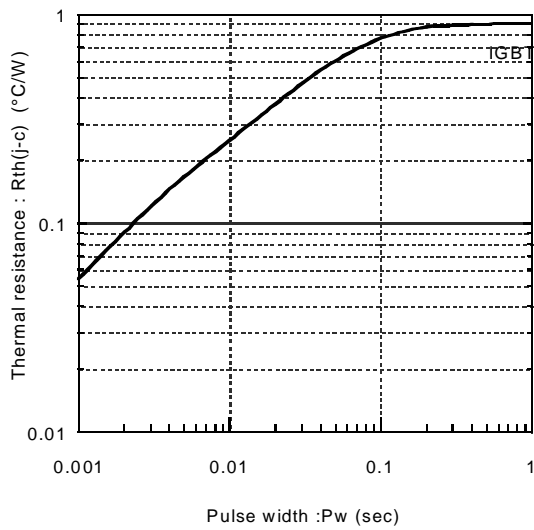
Collector current vs. Collector-Emmitter voltage (typ.)  
 $T_j=25^{\circ}\text{C}$



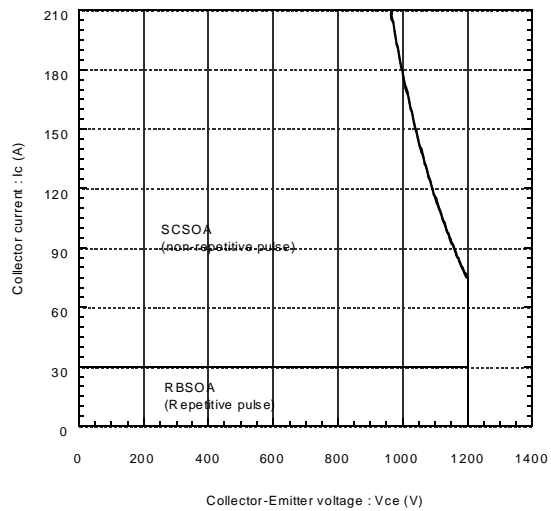
Collector current vs. Collector-Emmitter voltage (typ.)  
 $T_j=125^{\circ}\text{C}$



Transient thermal resistance (max.)



Reversed biased safe operating area  
 $V_{cc}=15\text{V}, T_j \leq 125^{\circ}\text{C}$  (min.)



Power derating for IGBT (max.)  
 (per device)

